

MEMORANDUM OF UNDERSTANDING ("MOU")

By and Between

National Institute of Electronics & Information Technology

Plot No. 3, PSP Pocket, Sector-8

Dwarka, New Delhi-110077

("NIELIT")

And

Infineon Technologies Asia Pacific Pte Ltd,

Company Registration Number: 197000667M,

8 Kallang Sector, Singapore 349282

("Infineon")

NIELIT and Infineon are hereinafter referred to individually as the "Party" and collectively as the "Parties".

WHEREAS, NIELIT is an autonomous scientific society under the administrative control of Ministry of Electronics and Information Technology to carry out human resource development and related activities in the area of information, electronics and communications technology;

WHEREAS, Infineon is a global semiconductor leader in automotive, power systems and IoT enabling game-changing solutions for green and efficient energy, clean and safe mobility, as well as smart and secure IoT;

WHEREAS, the Parties desire to enter into this MoU to indicate their intentions to establish collaboration and explore opportunities to develop, support and enrich the research and development relating to applications of semiconductors, educational and training programs in the semiconductor technology fields that will be beneficial for both Parties;

WHEREAS, through this MOU, the Parties aim to establish the general intention and principles of the aforementioned collaboration between the Parties.

NOW THEREFORE, the Parties agree as follow:



1. SCOPE OF CO-OPERATION

The Parties agree to explore cooperation opportunities within the collaboration scope as outlined in this Section 1 and the model for such cooperation shall remain flexible to suit the specific requirements of each area of focus. Further the Parties agree that any definitive activities for the cooperation and the administrative and financial modalities applicable to the activities shall be subject to further discussion and established by a separate definitive agreement between the Parties.

1.1 The Parties endeavor to work together to promote, develop and establish application level research and development, education and training programs relating to semiconductor product information/technology in the following areas:

- a) Enrichment of NIELIT's curriculum. The Parties will work together to design and integrate Infineon's microcontroller product information and knowledge into the curriculum of NIELIT's Masters of Technology in IoT and Sensor Systems program. Going forward, the Parties may also work together to incorporate relevant Infineon product information into the curriculums of other academic courses offered by all NIELIT centres, including bachelor programs, non-formal courses, certification courses and online programs.
- b) Conducting guest lectures. For students to gain exposure to real-world applications of their studies, NIELIT will invite engineers from Infineon and/or its affiliates to conduct guest lectures to share trends and technologies of the semiconductor industry. NIELIT will also invite engineers from Infineon to participate in academic conferences, where relevant.
- c) Supporting student projects. Infineon will provide opportunities for students to use Infineon products in their projects or laboratory works through the provision of samples.
- d) Infineon product trainings. In order to familiarize and be equipped with knowledge of Infineon's products, Infineon will also provide trainings to NIELIT's teaching personnel and access to relevant online product and technical training.
- e) Any other areas of interest that may be mutually identified and agreed by the Parties from time to time, such as hosting hackathons together.

1.2 In consideration of Infineon's contributions under this MoU, during the term of the MoU, NIELIT agrees to use its best efforts to work with Infineon only to incorporate microcontroller product information and knowledge into its curriculums.

1.3 The Parties shall jointly review the progress of this MoU yearly. The review meeting may be carried out face to face, over phone conference or such other means as agreed between the Parties. Each Party shall be responsible its own costs and expenses relating to such review meeting.

2. Point of Contact

The Parties have appointed individuals named below as the liaison for all matters relating to this MoU.

Infineon

- a) Robert Tan
Contact Number: +65 6876 2620
Email: Robert.Tan@infineon.com
- b) Timothy Yong
Contact Number: +65 6876 3358
Email: Timothy.Yong@infineon.com

NIELIT

- a) Dr Madan Mohan Tripathi
Email: dg@nielit.gov.in



3. Information Disclosure

- 3.1 Each Party shall treat the contents and subject matter of this MoU, and any and all confidential information exchanged between the Parties relating to the matters stated in Section 1 (Scope of Cooperation) as confidential, unless the other Party gives its prior written consent to its (or any part thereof) disclosure. This confidentiality obligation shall not apply to information which is generally known, which can be shown to have been independently developed by the recipient, or which has been acquired from a third party without any breach of confidentiality obligation, or which are, or become, public knowledge through no act or failure to act of the recipient. This obligation shall likewise not apply if a Party is required by statutory regulations to reveal any of the information it has obtained.
- 3.2 Any course materials bearing Infineon product's information ("Course Material – Infineon Product Information") shall be provided to Infineon at least one (1) month prior to the first session of the academic course and Infineon reserves the right to review the Course Material – Infineon Product Information. If Infineon elects to review the Course Material – Infineon Product Information, such review is strictly limited to only the representation of the Infineon product information in the course materials, Infineon shall in no event be made responsible for the contents of the academic course. University warrants that it will utilize (a) the information provided by Infineon and (b) the Course Material – Infineon Product Information strictly only for the academic course and will in no event provide it to any third party without the prior written approval of Infineon.
- 3.3 Information provided by either Party under this MoU is provide AS-IS with no warranty.

4. Legally Binding Provisions

This MoU constitutes only a preliminary, non-binding statement of the intentions of the Parties, does not contain all matters upon which agreement must be reached for any definitive agreement and creates no legal obligations on the part of any Party hereto with respect to executing the obligations under Section 1 (Scope of Cooperation). A binding commitment with respect to the obligations under Section 1 (Scope of Cooperation) will result only from the execution the definitive binding agreement. Notwithstanding the foregoing, the provisions of Sections 3 (Information Disclosure) to 6 (Miscellaneous) hereof will be fully binding on the Parties upon the execution of this MoU.

Neither of the Parties shall have ground for any claims against the other Party under this MoU (for example - without limitation - claims for damages, cost reimbursement and the like). Each Party shall bear its own internal and external costs connected with this MoU

5. Term

This MoU shall become effective as of the date of signatures by the duly authorized representatives of both Parties and shall thereafter remain in effect for a period of three (3) years unless terminated by either Party in accordance with this MoU. Either Party may terminate this MoU unilaterally for any reason by giving thirty (30) days' prior written notice. Sections 3 (Information Disclosure) and 6 (Miscellaneous) shall survive termination or expiration.

6. Miscellaneous

- 6.1 Neither Party may assign MoU, transfer its obligations or assign its rights hereunder without the prior written consent of the other Party, which consent shall not be unreasonably withheld. Notwithstanding the foregoing, and without consent of the other Party, (i) Infineon may assign this MoU, transfer its obligations or assign its rights hereunder to one of its Affiliates; and (ii) Infineon may assign this MoU, transfer its obligations or assign its rights hereunder to a third party to whom all or substantially all assets of the business unit performing this MoU are transferred.
- 6.2 Any additions or amendments to this MoU shall only be valid if made in writing and signed by the Parties; this written form requirement shall also be considered fulfilled where signatures are exchanged electronically on scanned copies via fax or email (PDF scan), or an electronic signature process is used (e.g. DocuSign or Adobe Sign). This written form requirement can only be waived or changed as set forth in the preceding sentence.

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- 6.3 The effectiveness of this MoU shall not be impaired if any provision of this MoU should be completely or partially invalid or unenforceable. In this case, the Parties shall agree on a provision that meets the economical intention of the invalid or unenforceable provision.
- 6.4 This MoU constitutes the entire agreement between the Parties hereto with respect to the subject matter hereof and supersedes all previous communications, discussions, understandings, agreements and negotiations between the Parties with respect to such subject matter hereof. General terms and conditions of neither Party shall apply within the scope of this MoU.

IN WITNESS WHEREOF, the Parties hereto have caused this MoU to be executed by their respective duly authorized representatives:

National Institute of Electronics & Information Technology

Signature: _____

Printed Name: _____

Title: _____

Date: _____

डॉ. मदन मोहन त्रिपाठी / Dr. Madan Mohan Tripathi

महानिदेशक / Director General

राष्ट्रीय इलेक्ट्रॉनिक्स एवं सूचना प्रौद्योगिकी संस्थान (रा.इ.सू.प्रौ.सं.)

National Institute of Electronics and Information Technology (NIELIT)

नाइलिट भवन, प्लॉट नं. 3, पीएसपी पॉकेट, इंस्टीट्यूशनल एरिया

NIELIT Bhawan, Plot No. 3, PSP Pocket, Institutional Area

Sector-8, Dwarka, New Delhi-110077

Signature: _____

Printed Name: _____

Title: _____

Date: _____

Chua Chee Seong
President and Managing Director

10/3/2025

ALOK TRIPATHI

Director

17.3.2025

डॉ. आलोक त्रिपाठी / Dr. ALOK TRIPATHI

निदेशक (योजना/कौशल) एवं मुख्य परीक्षा निदेशक

Director (Scheme/Skilling) & Chief Controller of Examinations

राष्ट्रीय इलेक्ट्रॉनिक्स एवं सूचना प्रौद्योगिकी संस्थान (रा.इ.सू.प्रौ.सं.)

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Kenneth Lim
Senior Vice President
Automotive Regional Segment
Asia Pacific

10 MAR 2025